



JIANGSU CHANGJIANG ELECTRONICS TECHNOLOGY CO., LTD

SOT-363 Plastic-Encapsulate Diodes

BAV199DW Multi-Chip DIODES

FEATURES

Power dissipation

$$P_{CM}: 0.2 \text{ W (Tamb=25}^{\circ}\text{C)}$$

Collector current

$$I_F : 200 \text{ mA}$$

Collector-base voltage

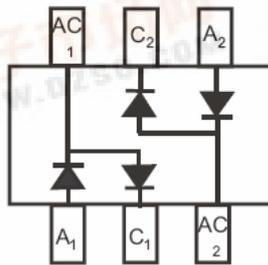
$$V_R : 85 \text{ V}$$

Operating and storage junction temperature range

$$T_J, T_{stg}: -55^{\circ}\text{C to } +150^{\circ}\text{C}$$



MARKING:K52

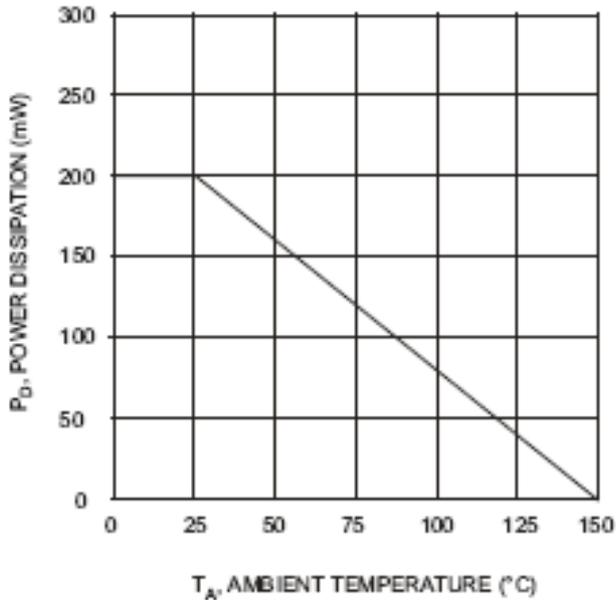


ELECTRICAL CHARACTERISTICS (Tamb=25°C unless otherwise specified)

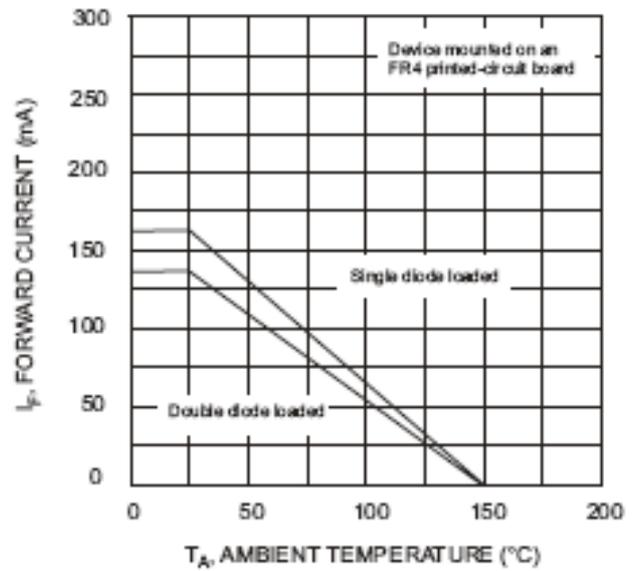
Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Reverse breakdown voltage	$V_{(BR)R}$	$I_R = 100\mu\text{A}$	85			V
Reverse voltage leakage current	I_R	$V_R = 75\text{V}$			5	nA
Forward voltage	V_F	$I_F = 1\text{mA}$ $I_F = 10\text{mA}$ $I_F = 50\text{mA}$ $I_F = 150\text{mA}$			0.9 1.0 1.1 1.25	V
Junction capacitance	C_j	$V_R = 0\text{V}$ $f = 1\text{MHz}$		2		pF
Revers recovery time	t_{rr}	$I_F = I_R = 10\text{mA}$ $I_{rr} = 0.1I_R$ $R_L = 100\Omega$			3	nS

Typical Characteristics

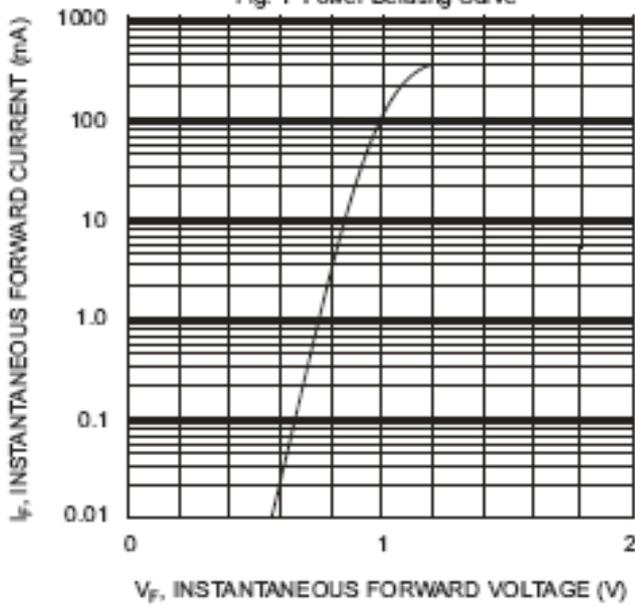
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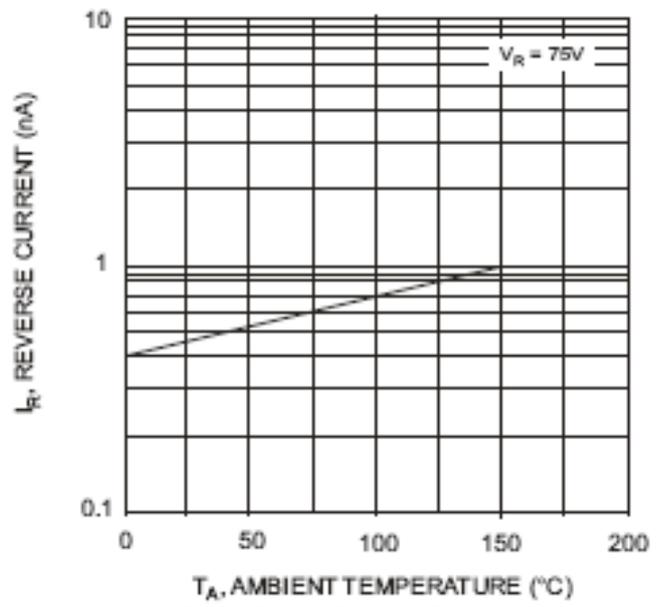
T_A , AMBIENT TEMPERATURE (°C)
Fig. 1 Power Derating Curve



T_A , AMBIENT TEMPERATURE (°C)
Fig. 2 Current Derating Curve



V_F , INSTANTANEOUS FORWARD VOLTAGE (V)
Fig. 3 Typical Forward Characteristics



T_A , AMBIENT TEMPERATURE (°C)
Fig. 4 Typical Reverse Characteristics